

Abstract

Electronic component and method for producing it

The invention relates to an electronic component (1) comprising a semiconductor chip (2) which comprises on its active top side (4) above an active surface area (5) a self-supporting electrically conductive cover layer (9) which is supported by through lines (10) and forms a hollow space (11) to the active surface area (5). The invention also relates to a method for producing the electronic component (1).

(Figure 1)